

### **SPECIFICATION SHEET**

SPECIFICATION SHEET NO.	N0310-MBS010S000S10A
DATE	Mar. 10, 2021
REVISION	A0
DESCRIPITION	SMD Single Phase Glass Passivated Bridge Rectifier, MBS Series,
	MB10S Type 4 Pins,
	Reverse Voltage 1000V Max. Forward Current 1.0A Max.
	Operating Temp. Range -55°C ~+150°C,
	Package in Tape/Reel, 3000pcs/Reel
	RoHS/RoHS III compliant
CUSTOMER	
CUSTOMER PART NUMBER	
CROSS REF. PART NUMBER	
ORIGINAL PART NUMBER	MDD MB10S
PART CODE	MBS010S000S10A

#### **VENDOR APPROVE**

Issued/Checked/Approved







DATE: March 10, 2021

CUSTOMER APPROVE	
DATE:	



## **SMD BRIDGE RECTIFER MBS SERIES**

#### **MAIN FEATURE**





- Reliable low cost construction utilizing molded plastic technique
- Small size simple installation
- · High surge current capability
- High temperature soldering guaranteed.
- 260 °C/10 seconds, at 5 lbs (2.3kg) tension

#### **APPLICATION**

• For printed circuit board

#### PART CODE GUIDE



MBS	0105000	S	10A
1	2	3	4

1) MBS: SMD Single Phase Glass Passivated Bridge Rectifier, 4 pins, MBS Series

2) 010S000: Type code for original part number MBS10S

3) S: Package code, Tape/reel, 3000pcs/reel.

4) 10A: Specification code for Reverse Voltage 1000V Max. Forward Current 1.0A Max.

#### **MORE ITEMS AVAILABLE**

MBS002S000S120	MBS004S000S140	MBS006S000S160	MBS008S000S180	MBS010S000S10A
MBS014S000S104	MBS016S000S106	MBS0110S00S110	MBS0120S00S210	
MBS024S000S204	MBS026S000S206	MBS028S000S208	MBS0210S00S210	MBS0220S00S220
MBSE02S000S110	MBSE004S00S120	MBSE006S00S140	MBSE008S00S160	
MBSR002S00S120	MBSR004S00S140	MBSR006S00S160	MBSR008S00S180	MBSR010S00S10A
MBSU002S00S120	MBSU004S00S140	MBSU006S00S160	MBSU008S00S180	MBSU010S00S10A

## **SMD BRIDGE RECTIFER MBS SERIES**

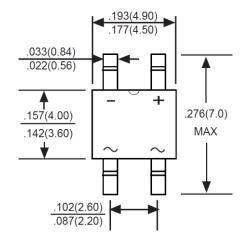
### **DIMENSION (Unit: Inch/mm)**

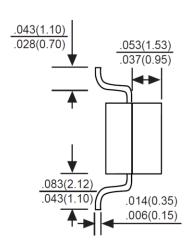


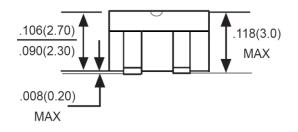


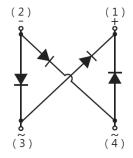
Marking: MB10S

**MBS** 

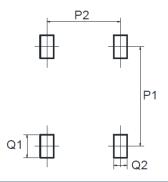








#### **Recommend Pad Layout**



Symbol	Min. (Inch)	Min. (mm)
P1	0.236	6.00
P2	0.094	2.40
Q1	0.072	1.84
Q2	0.047	1.20



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#### **MECHANICAL DATA**

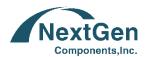
Case	Terminals	Polarity	Mounting Position	Weight per piece
JEDEC MBS molded plastic body	Solder plated, Solderable per MIL-STD-750, Method 2026	Polarity symbol marking on case	Any	0.0035 Ounce, 0.1080 grams

#### **MAX. RATING & CHARACTERISTICS**

Parameter		SYMBOLS	VALUE			UNITS
			Min.	Typical	Max.	
Repetitive peak reverse voltage		V RRM			1000	Volts
RMS voltage		V RMS			700	Volts
DC blocking voltage		V DC			1000	Volts
Average forward output rectified curr	rent	I AV			1.0	А
at Tc= 30°C						
On glass-epoxy PCB						
On aluminum substrate						
Peak forward surge current 8.3ms sin	Peak forward surge current 8.3ms single half			35		Α
sine-wave superimposed on rated loa	nd					
(JEDEC Method)						
Instantaneous forward voltage at 0.4	A	V F			1.10	Volts
DC reverse current at rated DC	TA=25°C	l R			5	μΑ
blocking voltage	TA=125°C				500	μΑ
Junction capacitance	Junction capacitance			13		pF
Thermal resistance (Note 4)		R QJA		70		°C/W
Operating junction temperature range		TJ	-55		+150	
Storage temperature range		T stg	-55		+150	°C

#### Note

- 1. Ratings at 25 C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.
- 2. On glass epoxy PCB mounted on 0.05\*0.05" (1.3\*1.3mm) pads
- 3. On aluminum substrate PCB with on area of 0.8\*0.8" (20\*20mm) mounted on 0.05\*0.05" (1.3\*1.3mm) solder pads
- 4. Measured at 1.0MHz and applied reverse voltage of 4.0Voltage



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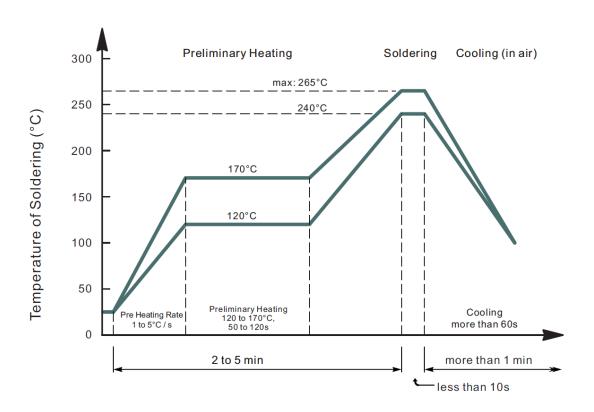
#### **RELIABILITY**

Number	Experiment Items	Experiment Method And Conditions	Reference Documents
1	Solder Resistance Test	Test 260°C± 5°C for 10 ± 2 sec. Immerse body into solder 1/16" ± 1/32"	MIL-STD-750D METHOD-2031.2
2	Solderability Test	230°C ±5°C for 5 sec.	MIL-STD-750D METHOD-2026.1 0
3	Pull Test	1 kg in axial lead direction for 10 sec.	MIL-STD-750D METHOD-2036.4
4	Bend Test	0.5Kg Weight Applied To Each Lead, Bending Arcs 90 °C ± 5 °C For 3 Times	MIL-STD-750D METHOD-2036.4
5	High Temperature Reverse Bias Test	TA=100°C for 1000 Hours at VR=80% Rated VR	MIL-STD-750D METHOD-1038.4
6	Forward Operation Life Test	TA=25°C Rated Average Rectified Current	MIL-STD-750D METHOD-1027.3
7	Intermittent Operation Life Test	On state: 5 min with rated IRMS Power Off state: 5 min with Cool Forced Air. On and off for 1000 cycles.	MIL-STD-750D METHOD-1036.3
8	Pressure Cooker Test	15 PSIG, Ta=121°C, 4 hours	MIL-S-19500 APPENOIXC
9	Temperature Cycling Test	-55°C~+125°C; 30 Minutes For Dwelled Time 5 minutes for transferred time. Total: 10 cycles.	MIL-STD-750D METHOD-1051.7
10	Thermal Shock Test	0°C for 5 minutes., 100°C for 5minutes, Total: 10 cycles	MIL-STD-750D METHOD-1056.7
11	Forward Surge Test	8.3ms Single Sale Sine-wave One Surge.	MIL-STD-750D METHOD-4066.4
12	Humidity Test	Ta=65°C, RH=98% for 1000 hours.	MIL-STD-750D METHOD-1021.3
13	High Temperature Storage life Test	150°C for 1000 Hours	MIL-STD-750D METHOD-1031.5

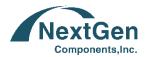


### **SMD BRIDGE RECTIFER MBS SERIES**

#### **SUGGESTED REFLOW PROFILE (For Reference Only)**

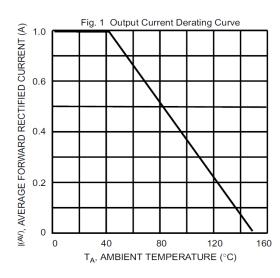


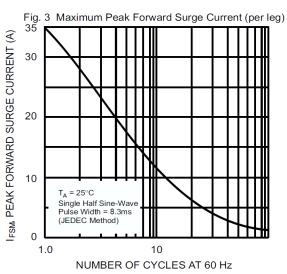
- Recommended peak temperature is over 245°C, If peak temperature is below 245 °C, you may adjust the
  following parameters; time length of peak temperature (longer), time length of soldering (longer), thickness of
  solder paste (thicker)
- · Welding shall not exceed 2 times
- Remark: lead free solder paste (96.5 sn/3.0 Ag/0.5Cu)

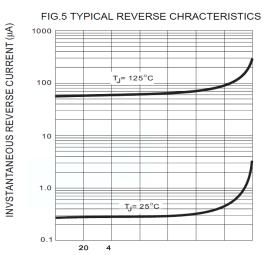


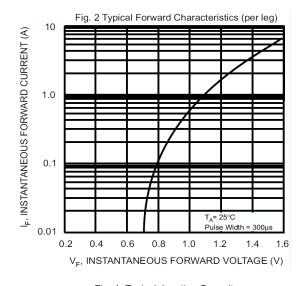
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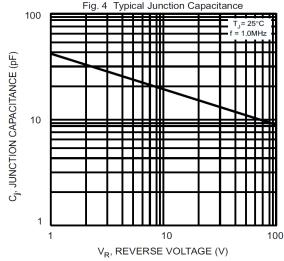
#### **RATINGS AND CHARACTERISTIC CURVES (For Reference Only)**

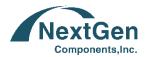








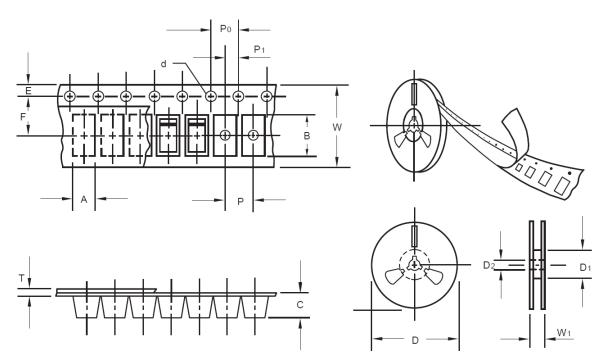




# **SMD BRIDGE RECTIFER MBS SERIES**

#### TAPE/REEL (Unit: mm)

All Devices are packed in accordance with EIA standard RS-481-A and specifications.



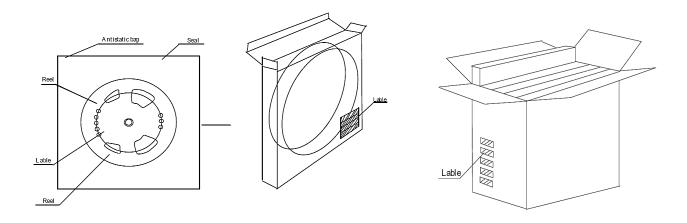
Item	Symbol	Tolerance	MBS
Carrier width	А	0.1	2.8
Carrier Length	В	0.1	5.33
Carrier Depth	С	0.1	2.36
Sprocket hole	d	0.05	1.50
13"Reel outside diameter	D	2.0	330.00
13"Reel inner diameter	D1	Min.	50.00
7"Reel outside diameter	D	-	-
7"Reel inner diameter	D1	-	-
Feed hole diameter	D2	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	5.50
Punch hole pitch	Р	0.1	4.00
Sprocket hole pitch	PO	0.1	4.00
Embossment center	P1	0.1	2.0
Overall tape thickness	Т	0.1	0.28
Tape width	W	0.3	12.00
Reel width	W1	1.0	18.0



# SMD BRIDGE RECTIFER MBS SERIES

#### **PACKAGE**

Case Code	Reel Size	MPQ (pcs)	Component Spacing (mm)	Qty. Per Box (pcs)	Inner Box L*W*H (mm)	Reel Size (mm)	Carton size L*W*H (mm)	Qty. Per Carton (pcs)	G. W (kg)
MBS	13"	3,000	-	6,000	190*190*41	330	370*370*380	48,000	12.0



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